## 1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP2-HP (SOD323HP) power flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Low forward voltage
- Low Q<sub>rr</sub> and low I<sub>RM</sub>
- · Low leakage current
- High power capability due to clip-bonding technology
- Power flat lead plastic package with exposed heatsink for optimal thermal connection

## 3. Applications

- · High efficiency DC-to-DC conversion
- Switch mode power supply
- · Freewheeling applications
- · Reverse polarity protection
- OR-ing

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> $\leq$ 172 °C		-	-	1	A
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	45	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	450	520	mV
I <sub>R</sub>	reverse current	$V_R = 45 \text{ V}$ ; pulsed; $T_j = 25 \text{ °C}$	[1]	-	3	20	μΑ
		$V_R = 45 \text{ V}$ ; pulsed; $T_j = 125 ^{\circ}\text{C}$	[1]	-	2.5	8	mA

[1] Very short pulse, in order to maintain a stable junction temperature.



# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	A	anode	Transparent top view  CFP2-HP (SOD323HP)	K <del>【【</del> A sym001

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	pe number Package						
	Name	Description	Version				
PMEG45T10EXD	CFP2-HP	SOD323HP: plastic surface-mounted package with solderable lead ends; 2.2 mm x 1.3 mm x 0.68 mm body	SOD323HP				

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG45T10EXD	2н

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	45	V
I <sub>F</sub>	forward current	δ = 1; T <sub>sp</sub> ≤ 171 °C		-	1.4	А
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; $T_{sp} \le$ 172 °C		-	1	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	15	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	0.65	W
			[2]	-	1.2	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

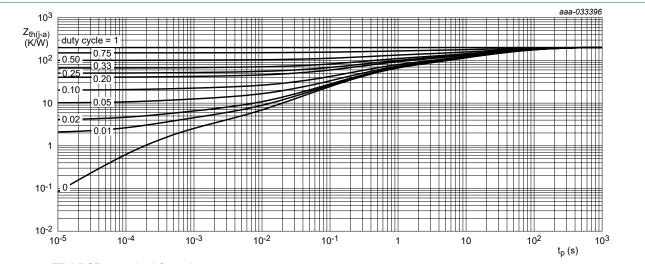
- Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

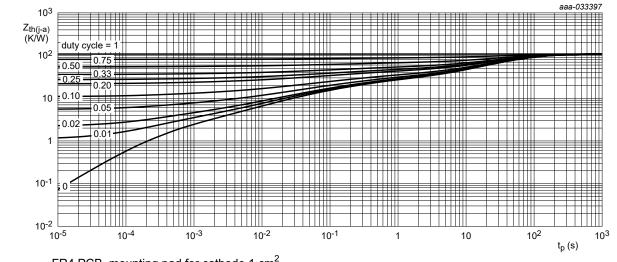
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1] [2]	-	-	230	K/W
jun	junction to ambient		[1] [3]	-	-	125	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	6	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

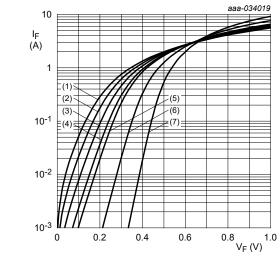
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R$ = 1 mA; pulsed; $T_j$ = 25 °C	[1]	45	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	330	380	mV
		I <sub>F</sub> = 0.5 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	400	450	mV
		I <sub>F</sub> = 0.7 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	420	470	mV
		I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	450	520	mV
		I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = -40 °C	[1]	-	505	575	mV
		I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 125 °C	[1]	-	360	430	mV
		I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 150 °C	[1]	-	340	410	mV
$I_R$	reverse current	V <sub>R</sub> = 10 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	1.5	8.8	μΑ
		V <sub>R</sub> = 45 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	3	20	μΑ
		$V_R$ = 45 V; pulsed; $T_j$ = 125 °C	[1]	-	2.5	8	mA
		$V_R = 45 \text{ V}$ ; pulsed; $T_j = 150 \text{ °C}$	[1]	-	10	35	mA
C <sub>d</sub>	diode capacitance	$V_R = 4 \text{ V}; f = 1 \text{ MHz}; T_j = 25 ^{\circ}\text{C}$		-	130	-	pF
		$V_R = 10 \text{ V}; f = 1 \text{ MHz}; T_j = 25 \text{ °C}$		-	80	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}$ ; $I_R = 1 \text{ A}$ ; $I_{R(meas)} = 0.25 \text{ A}$ ; $I_{j} = 25 \text{ °C}$		-	4.5	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 100 \text{ A/}\mu\text{s}; I_F = 1 \text{ A}; V_R = 30 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$		-	8	-	ns
I <sub>RM</sub>	peak reverse recovery current			-	0.36	-	Α
Q <sub>rr</sub>	reverse recovery charge			-	2	-	nC
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	405	-	mV

<sup>[1]</sup> Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) Tj = 175 °C

(2) Tj = 150 °C

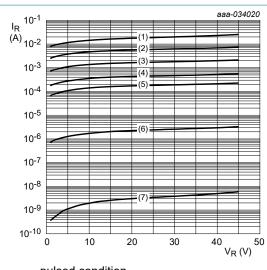
(3) Tj = 125 °C

(4) Tj = 100 °C

(5) Tj = 85 °C

(6) Tj =  $25 \, ^{\circ}$ C (7) Tj = -40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



pulsed condition

(1)  $T_i = 175 \, ^{\circ}C$ 

(2)  $T_i = 150 °C$ 

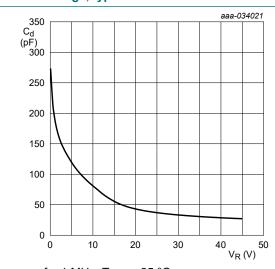
 $(3) T_i = 125 °C$ 

 $(4) T_i = 100 °C$ 

 $(5) T_i = 85 ^{\circ}C$ (6)  $T_i = 25 \,^{\circ}\text{C}$ 

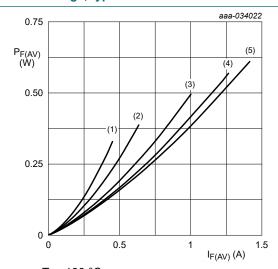
(7)  $T_i = -40$  °C

Reverse current as a function of reverse Fig. 4. voltage; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ °C}$ 

Fig. 5. Diode capacitance as a function of reverse voltage; typical values



T<sub>i</sub> = 100 °C

 $(1) \delta = 0.1$ 

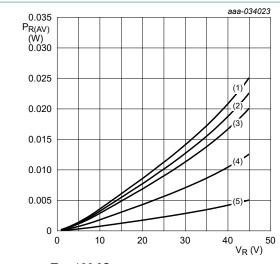
(2)  $\delta = 0.2$ 

 $(3) \delta = 0.5$ 

 $(4) \delta = 0.8$ 

(5)  $\delta = 1$ ; DC

Average forward power dissipation as a Fig. 6. function of average forward current; typical values



 $T_j = 100 \, ^{\circ}C$ 

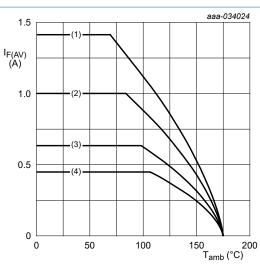
 $(1) \delta = 1; DC$ 

 $(2) \delta = 0.9$ 

 $(3) \delta = 0.8$  $(4) \delta = 0.5$ 

 $(4) \delta = 0.3$  $(5) \delta = 0.2$ 

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T<sub>i</sub> = 175 °C

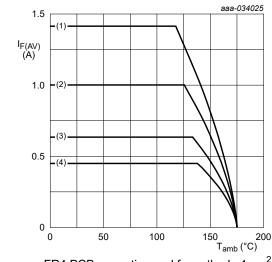
 $(1) \delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

T<sub>i</sub> = 175 °C

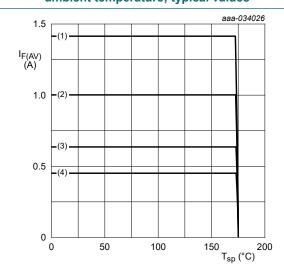
 $(1) \delta = 1$ ; DC

 $(2) \delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Tj = 175 °C

(1)  $\delta$  = 1; DC

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

**Product data sheet** 

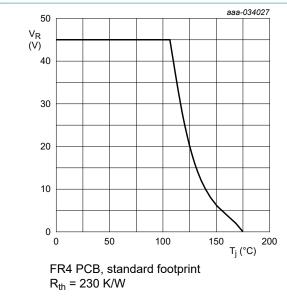
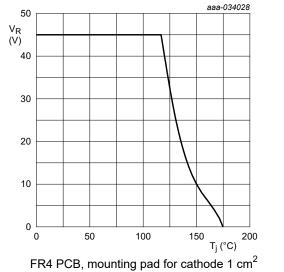
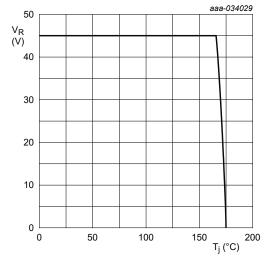


Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



 $R_{th} = 125 \text{ K/W}$ 

of junction temperature; typical values



Soldering point of cathode tab  $R_{th} = 6 \text{ K/W}$ 

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

# 11. Test information

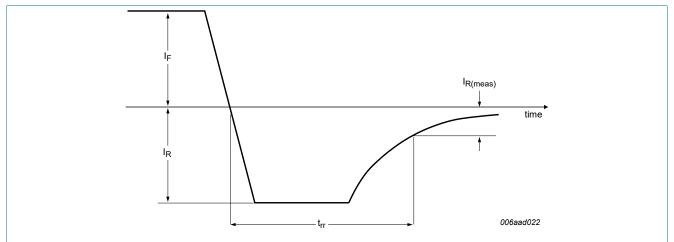


Fig. 14. Reverse recovery definition; step recovery

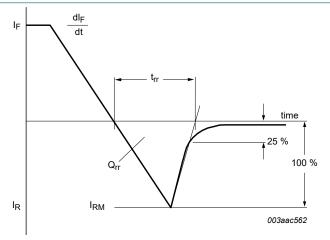


Fig. 15. Reverse recovery definition; ramp recovery

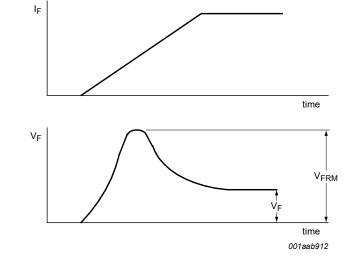
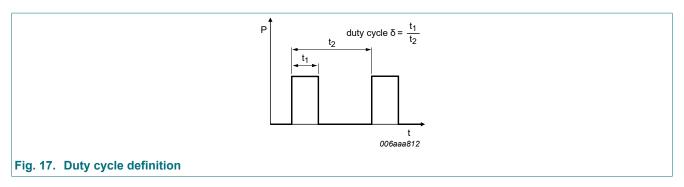


Fig. 16. Forward recovery definition



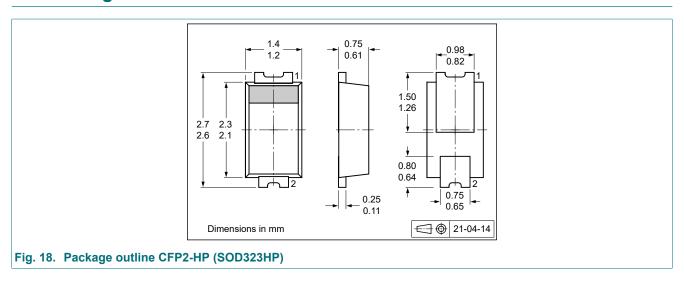
The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

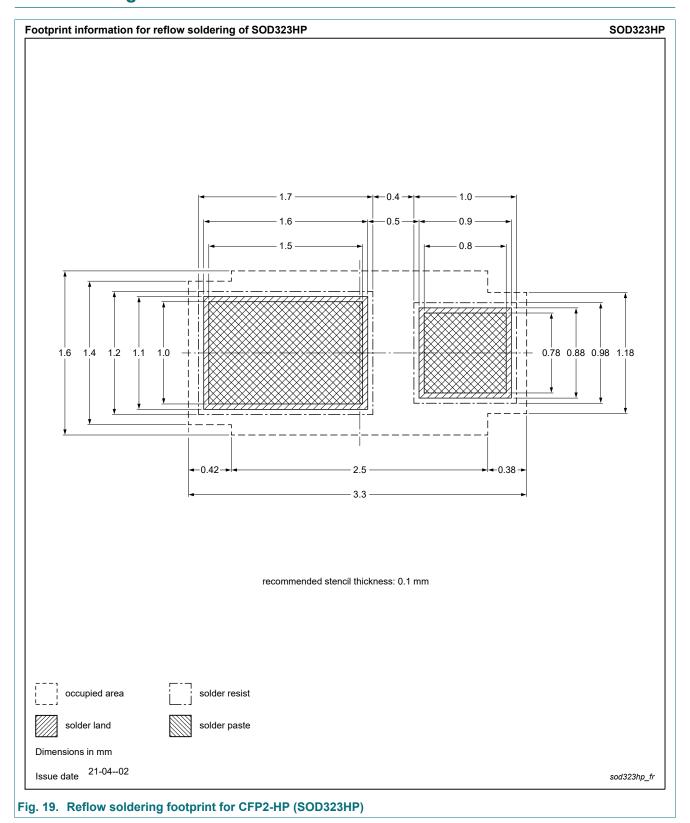
 $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_{M} \times \sqrt{\delta}$ 

with  $I_{\mbox{\scriptsize RMS}}$  defined as RMS current.

# 12. Package outline



# 13. Soldering



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# 14. Revision history

#### **Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG45T10EXD v.1	20220104	Product data sheet	-	-

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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PMEG45T10EXD

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